

ST733C..L SERIES

INVERTER GRADE THYRISTORS

Hockey Puk Version

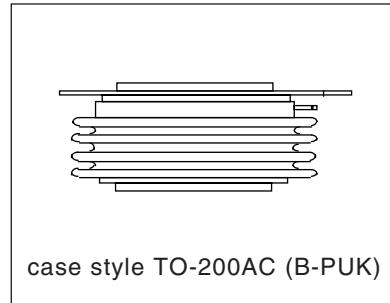
Features

- Metal case with ceramic insulator
- International standard case TO-200AC (B-PUK)
- All diffused design
- Center amplifying gate
- Guaranteed high dV/dt
- Guaranteed high di/dt
- High surge current capability
- Low thermal impedance
- High speed performance

940A

Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters



Major Ratings and Characteristics

Parameters	ST733C..L	Units
$I_{T(AV)}$	940	A
@ T_{hs}	55	°C
$I_{T(RMS)}$	1900	A
@ T_{hs}	25	°C
I_{TSM}	20000	A
@ 60Hz	20950	A
I^2t	2000	KA ² s
@ 60Hz	1820	KA ² s
V_{DRM}/V_{RRM}	400 to 800	V
t_q range	10 to 20	μs
T_J	- 40 to 125	°C

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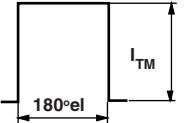
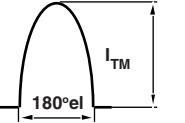
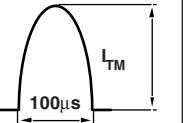
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ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , maximum repetitive peak voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$. mA
ST733C..L	04	400	500	75
	08	800	900	

Current Carrying Capability

Frequency				Units
50Hz	2200	1900	3580	A
400Hz	2050	1660	3600	
1000Hz	1370	1070	2900	
2500Hz	500	370	1220	
Recovery voltage V_r	50	50	50	V
Voltage before turn-on V_d	V_{DRM}	V_{DRM}	V_{DRM}	
Rise of on-state current dI/dt	50	50	-	A/ μ s
Heatsink temperature	40	55	40	°C
Equivalent values for RC circuit	10Ω / 0.47μF	10Ω / 0.47μF	10Ω / 0.47μF	

On-state Conduction

Parameter	ST733C..L	Units	Conditions			
$I_{T(AV)}$	Max. average on-state current @ Heatsink temperature	A	180° conduction, half sine wave double side (single side) cooled			
	55 (85)	°C				
$I_{T(RMS)}$	Max. RMS on-state current	1900	A	DC @ 25°C heatsink temperature double side cooled		
I_{TSM}	Max. peak, one half cycle, non-repetitive surge current	20000		t = 10ms	No voltage reapplied	Sinusoidal half wave, Initial $T_J = T_{J\max}$
	20950			t = 8.3ms		
	16800			t = 10ms	100% V_{RRM} reapplied	
	17600			t = 8.3ms	reapplied	
I^2t	Maximum I^2t for fusing	2000	KA ² s	t = 10ms	No voltage reapplied	Initial $T_J = T_{J\max}$
	1820			t = 8.3ms		
	1410			t = 10ms	100% V_{RRM} reapplied	
	1290			t = 8.3ms	reapplied	
$I^2\sqrt{t}$	Maximum $I^2\sqrt{t}$ for fusing	20000	KA ² /s	t = 0.1 to 10ms, no voltage reapplied		

On-state Conduction

Parameter	ST733C..L	Units	Conditions	
V_{TM}	Max. peak on-state voltage	1.63	V	$I_{TM} = 1700A, T_J = T_J \text{ max}, t_p = 10\text{ms sine wave pulse}$
$V_{T(TO)1}$	Low level value of threshold voltage	1.09		$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
$V_{T(TO)2}$	High level value of threshold voltage	1.20		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
r_{t1}	Low level value of forward slope resistance	0.32	$\text{m}\Omega$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
r_{t2}	High level value of forward slope resistance	0.29		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
I_H	Maximum holding current	600	mA	$T_J = 25^\circ\text{C}, I_T > 30\text{A}$
I_L	Typical latching current	1000		$T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega, I_G = 1\text{A}$

Switching

Parameter	ST733C..L	Units	Conditions
dI/dt	Max. non-repetitive rate of rise of turned-on current	$\text{A}/\mu\text{s}$	$T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}, I_{TM} = 2 \times dI/dt$ Gate pulse: 20V 20Ω, 10μs 0.5μs rise time
t_d	Typical delay time		$T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50\text{A DC}, t_p = 1\mu\text{s}$ Resistive load, Gate pulse: 10V, 5Ω source
t_q	Max. turn-off time	μs	$T_J = T_J \text{ max}, I_{TM} = 550\text{A}, \text{commutating } dI/dt = -40\text{A}/\mu\text{s}$ $V_R = 50\text{V}, t_p = 500\mu\text{s}, dv/dt: \text{see table in device code}$
	Min 10 Max 20		

Blocking

Parameter	ST733C..L	Units	Conditions
dv/dt	Maximum critical rate of rise of off-state voltage	$\text{V}/\mu\text{s}$	$T_J = T_J \text{ max. linear to } 80\% V_{DRM}, \text{higher value available on request}$
I_{RRM}	Max. peak reverse and off-state leakage current	mA	$T_J = T_J \text{ max, rated } V_{DRM}/V_{RRM} \text{ applied}$

Triggering

Parameter	ST733C..L	Units	Conditions
P_{GM}	Maximum peak gate power	W	$T_J = T_J \text{ max., } f = 50\text{Hz, } d\% = 50$
$P_{G(AV)}$	Maximum average gate power		
I_{GM}	Max. peak positive gate current	A	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$+V_{GM}$	Maximum peak positive gate voltage		
$-V_{GM}$	Maximum peak negative gate voltage	V	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
I_{GT}	Max. DC gate current required to trigger	mA	$T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega$
V_{GT}	Max. DC gate voltage required to trigger		
I_{GD}	Max. DC gate current not to trigger	mA	$T_J = T_J \text{ max, rated } V_{DRM} \text{ applied}$
V_{GD}	Max. DC gate voltage not to trigger		

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Thermal and Mechanical Specification

Parameter	ST733C..L	Units	Conditions
T_J	Max. operating temperature range	-40 to 125	°C
T_{stg}	Max. storage temperature range	-40 to 150	
R_{thJ-hs}	Max. thermal resistance, junction to heatsink	0.073 0.031	K/W
R_{thC-hs}	Max. thermal resistance, case to heatsink	0.011 0.005	K/W
F	Mounting force, $\pm 10\%$	14700 (1500)	N (Kg)
wt	Approximate weight	255	g
Case style	TO - 200AC (B-PUK)	See Outline Table	

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.009	0.009	0.006	0.006	K/W	$T_J = T_{J \text{ max.}}$
120°	0.011	0.011	0.011	0.011		
90°	0.014	0.014	0.015	0.015		
60°	0.020	0.021	0.021	0.022		
30°	0.036	0.036	0.036	0.036		

Ordering Information Table

Device Code	ST	73	3	C	08	L	H	K	1	
	1	2	3	4	5	6	7	8	9	10
1 - Thyristor										
2 - Essential part number										
3 - 3 = Fast turn off										
4 - C = Ceramic Puk										
5 - Voltage code: Code x 100 = V_{RRM} (See Voltage Rating Table)										
6 - L = Puk Case TO-200AC (B-PUK)										
7 - Reapplied dv/dt code (for t_q test condition)										
8 - t_q code _____										
9 - 0 = Eyelet term. (Gate and Aux. Cathode Unsoldered Leads) 1 = Fast-on term. (Gate and Aux. Cathode Unsoldered Leads) 2 = Eyelet term. (Gate and Aux. Cathode Soldered Leads) 3 = Fast-on term. (Gate and Aux. Cathode Soldered Leads)										
10 - Critical dv/dt: None = 500V/ μ sec (Standard value) L = 1000V/ μ sec (Special selection)										

dv/dt - t_q combinations available					
dv/dt (V/ μ s)	20	50	100	200	400
10	CN	DN	EN	--	--
12	CM	DM	EM	FM *	--
15	CL	DL	EL	FL *	HL
18	CP	DP	EP	FP	HP
20	CK	DK	EK	FK	H

* Standard part number.
All other types available only on request.

Outline Table

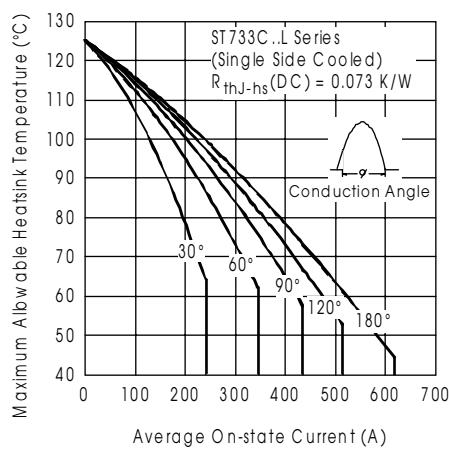
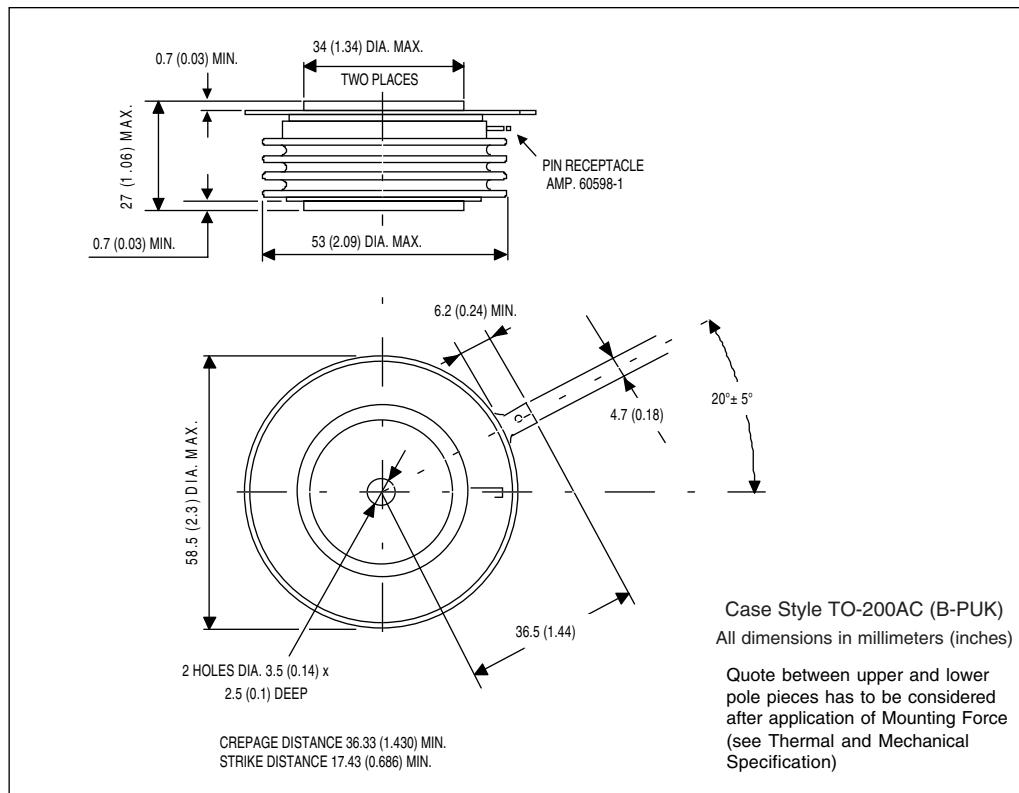


Fig. 1 - Current Ratings Characteristics

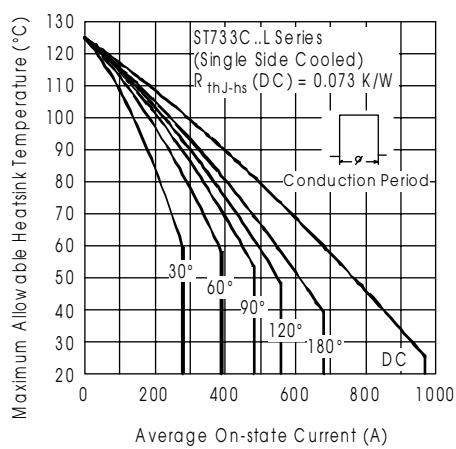


Fig. 2 - Current Ratings Characteristics

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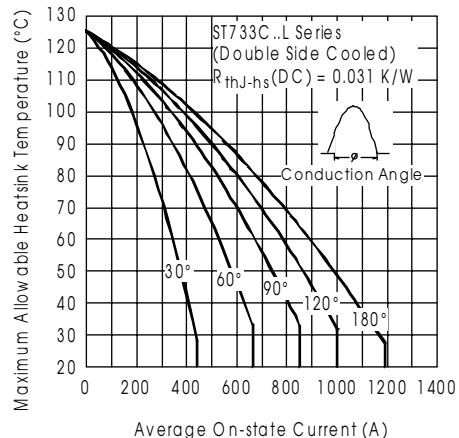


Fig.3-Current Ratings Characteristics

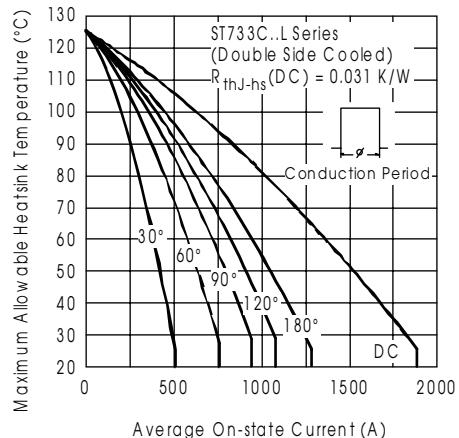


Fig.4-Current Ratings Characteristics

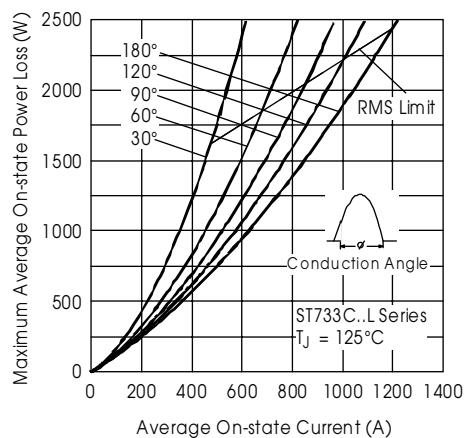


Fig.5-On-state Power Loss Characteristics

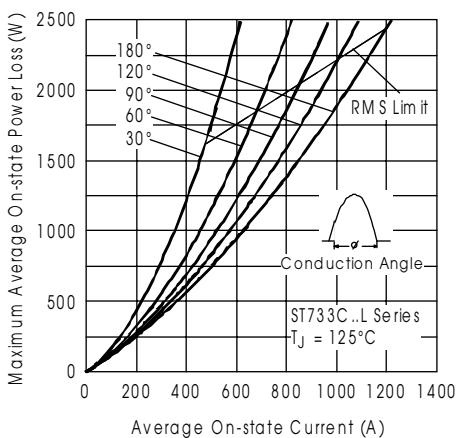


Fig.6-On-state Power Loss Characteristics

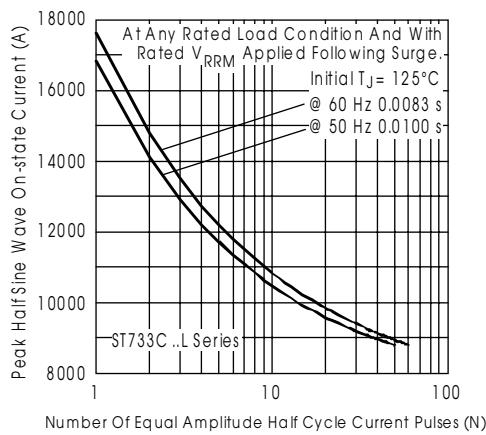


Fig.7-Maximum Non-repetitive Surge Current Single and Double Side Cooled

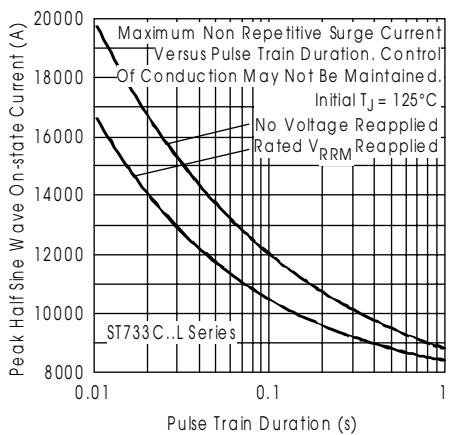


Fig.8-Maximum Non-repetitive Surge Current Single and Double Side Cooled

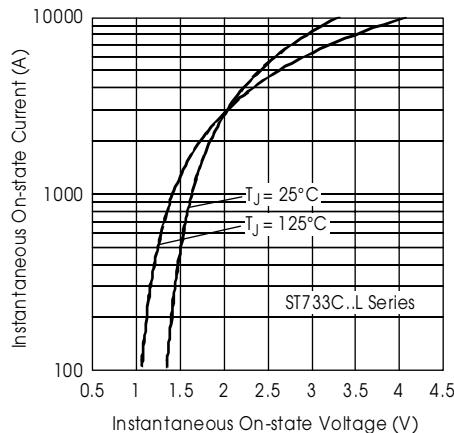


Fig.9-On-state Voltage Drop Characteristics

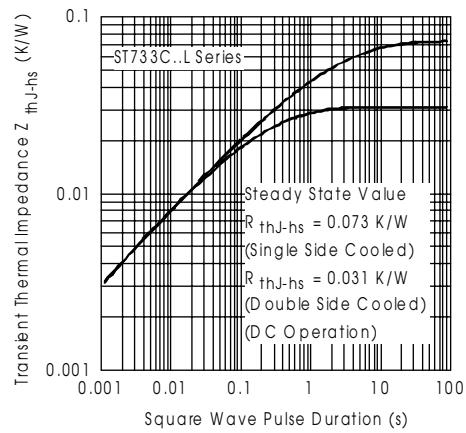


Fig.10-Thermal Impedance Z_{thJ-hs} Characteristic

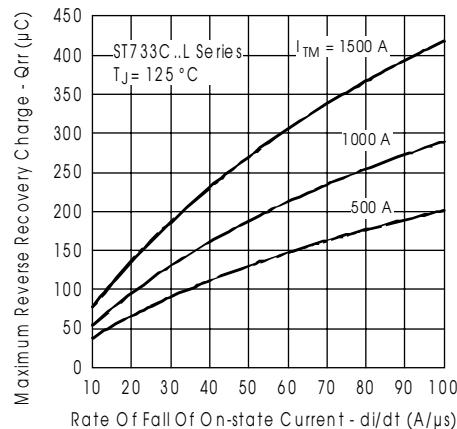


Fig.11-Reverse Recovered Charge Characteristics

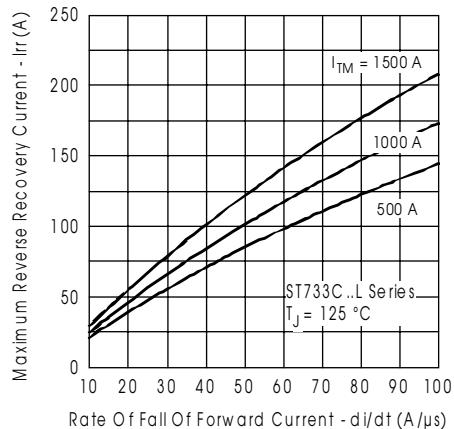


Fig.12-Reverse Recovery Current Characteristics

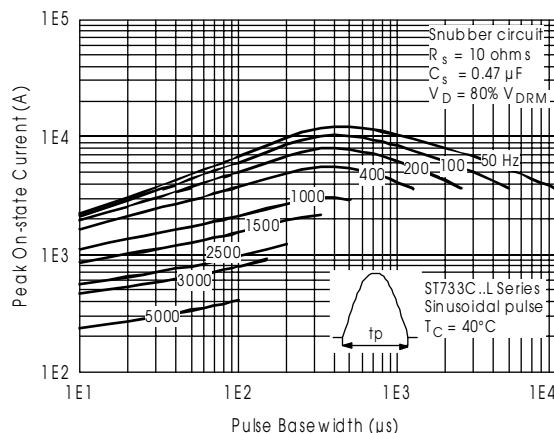
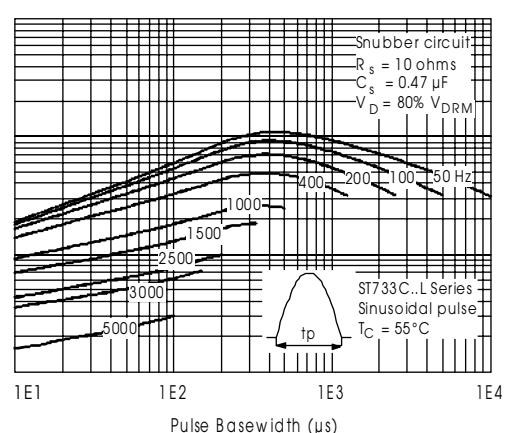


Fig.13-Frequency Characteristics



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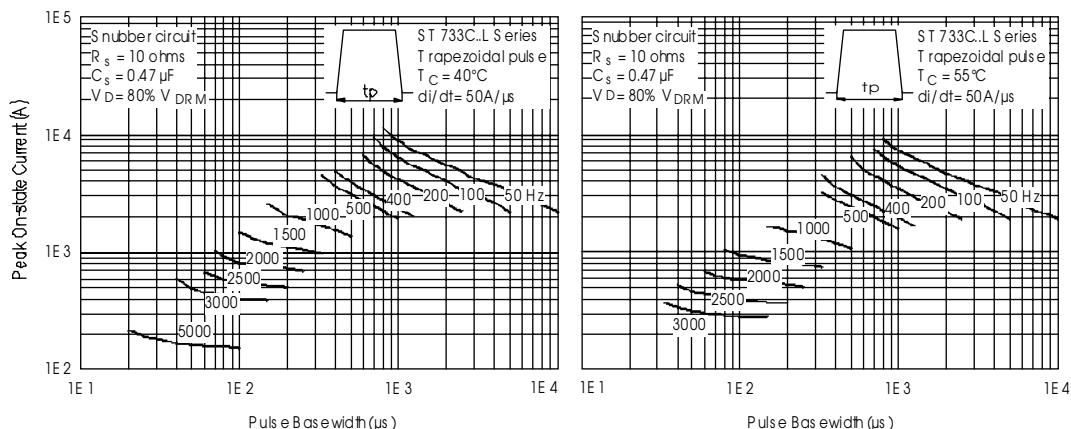


Fig. 14-Frequency Characteristics

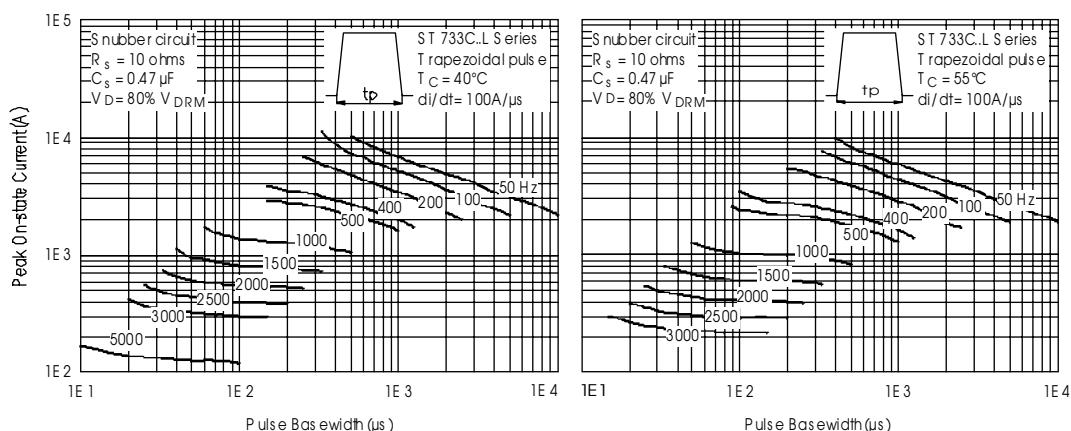


Fig. 15-Frequency Characteristics

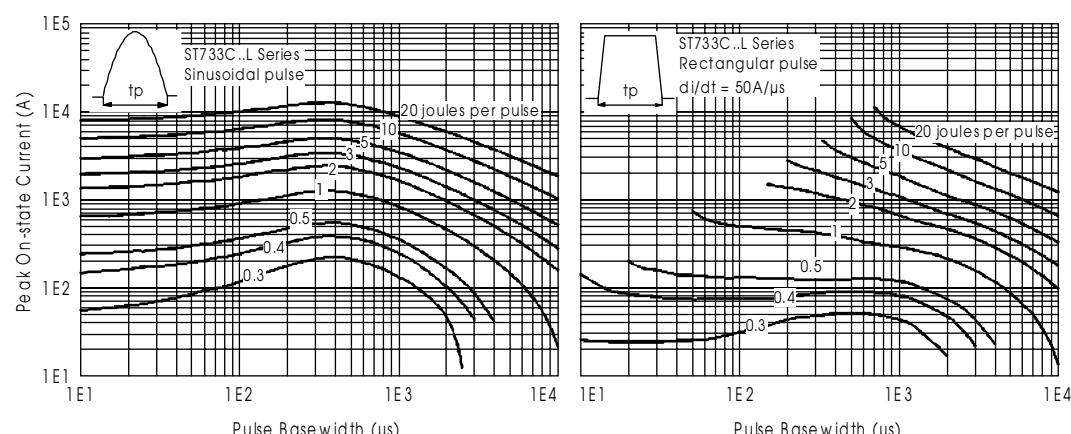


Fig. 16-Maximum On-state Energy Power Loss Characteristics

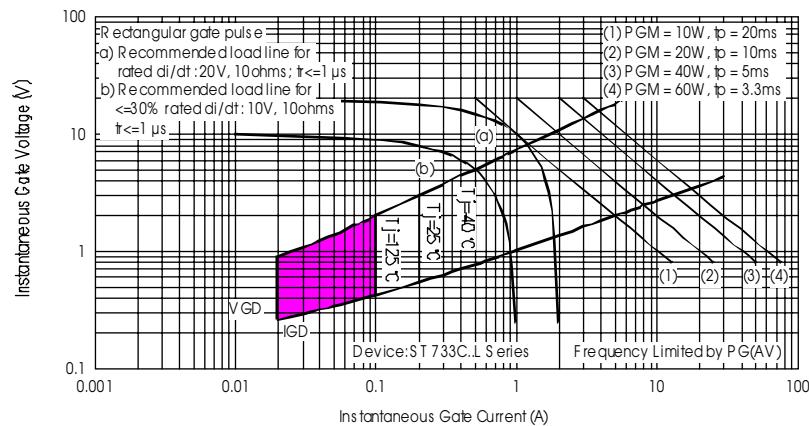


Fig. 17-Gate Characteristics